

SEMICONDUCTOR®

PN2369

NPN Switching Transistor

- This device is designed for high speed saturated switching at collector currents of 10mA to 100mA.
- Sourced from process 21.



1. Emitter 2. Base 3. Collector

Absolute Maximum Ratings* $T_a=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Ratings	Units	
V _{CEO}	Collector-Emitter Voltage	15	V	
V _{CBO}	Collector-Base Voltage	40	V	
V _{EBO}	Emitter-Base Voltage	4.5	V	
I _C	Collector Current - Continuous	200	mA	
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 ~ 150	°C	

* This ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

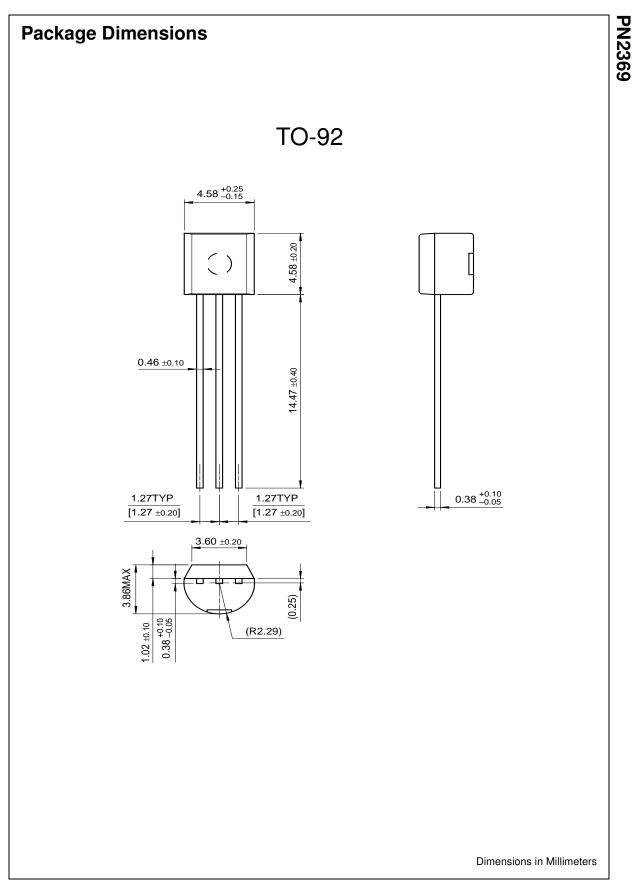
1) These rating are based on a maximum junction temperature of 150 degrees C.
2) These are steady limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics Ta=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Chara	cteristics	•		•	
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage *	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 0$	15		V
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	$I_{C} = 10\mu A, V_{BE} = 0$	40		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_{C} = 10\mu A, I_{E} = 0$	40		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_{\rm E} = 10\mu A, I_{\rm C} = 0$	4.5		V
I _{CBO}	Collector Cutoff Current	$V_{CB} = 20V, I_E = 0$		0.4	μA
		$V_{CB} = 20V, I_E = 0, T_a = 125^{\circ}C$		30	μA
On Charac	cteristics				
h _{FE}	DC Current Gain *	I _C = 10mA, V _{CE} = 1.0V	40	120	
		$I_{C} = 100 \text{mA}, V_{CE} = 2.0 \text{V}$	20		
V _{CE(sat)}	Collector-Emitter Saturation Voltage *	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 1.0 {\rm mA}$		0.25	V
V _{BE(sat)}	Base-Emitter Saturation Voltage	$I_{\rm C} = 10 {\rm mA}, I_{\rm B} = 1.0 {\rm mA}$	0.7	0.85	V
	nal Characteristics			-	
C _{obo}	Output Capacitance	$V_{CB} = 5.0V, I_E = 0, f = 1.0MHz$		4.0	pF
C _{ibo}	Input Capacitance	$V_{EB} = 0.5V, I_{C} = 0, f = 1.0MHz$		5.0	pF
h _{fe}	Small -Signal Current Gain	$\label{eq:linear} \begin{array}{l} I_C = 10 \text{mA}, V_{CE} = 10 \text{V}, R_G = 2.0 \text{k}\Omega, \\ \text{f} = 100 \text{MHz} \end{array}$	5.0		
Switching	Characteristics				
t _s	Storage Time	$I_{B1} = I_{B2} = I_{C} = 10 \text{mA}$		13	ns
t _{on}	Turn-On Time	V _{CC} = 3.0V, I _C = 10mA, I _{B1} = 3.0mA		12	ns
t _{off}	Turn-Off Time	$V_{CC} = 3.0V, I_C = 10mA, I_{B1} = 3.0mA, I_{B2} = 1.5mA$		18	ns

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Symbol	Parameter	Max.	Units
)	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
)C	Thermal Resistance, Junction to Case	125	°C/W
JA	Thermal Resistance, Junction to Ambient	357	°C/W



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